



MODEL NO: 17-21UBGC/TR8

Device Number : DSE-171-063 REV. 1.0

0805 Package Chip LEDs

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Features :

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

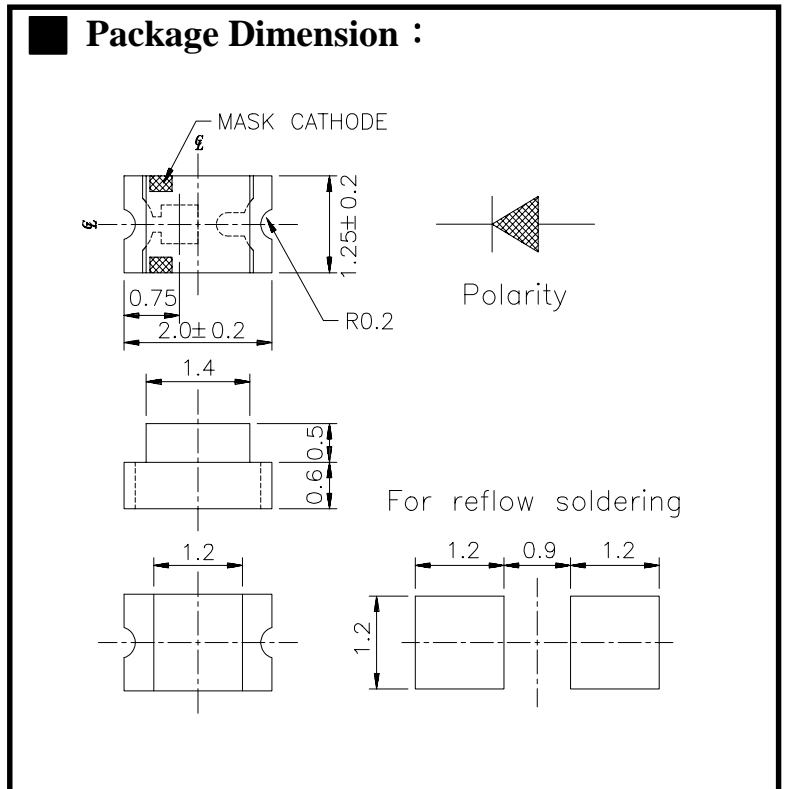
Description :

- The 17-21 SMD Taping is much smaller than leaded components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

Applications :

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and f
- Flat backlight for LCD, switch and symbol.
- General use.

Package Dimension :



Notes :

Tolerances Unless Dimension $\pm 0.1\text{mm}$
 Angle $\pm 0.5^\circ$
 Unit = mm

PART NO	CHIP		Lens Color
	Material	Emitted Color	
17-21UBGC/TR8	InGaN/SiC Substrate	Super Blue Green	Water Clear

Office: NO 25,Lane.76, Chung Yang Rd., Sec.3, Tucheng, Taipei 236, Taiwan, R.O.C.

TEL: 886-2-2267-2000,2266-9936(22 Lines)

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<http://www.everlight.com>



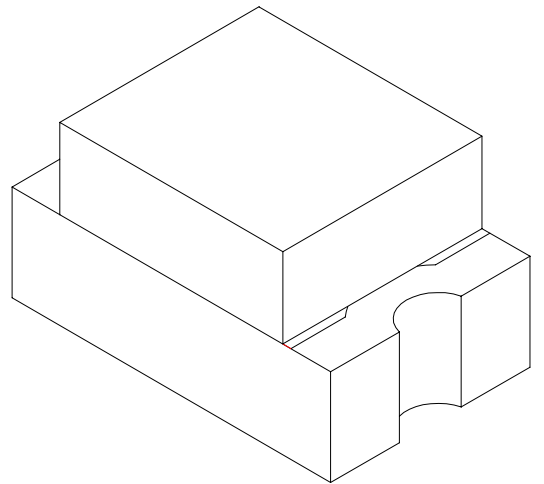
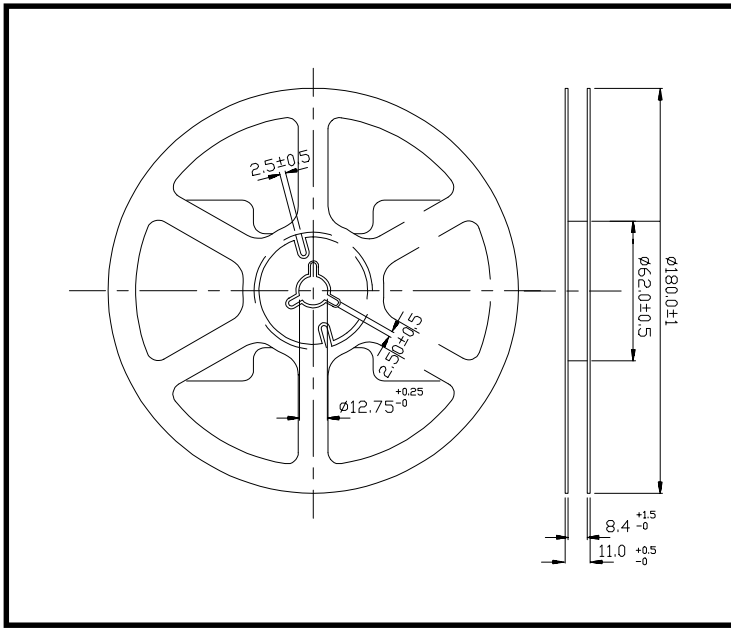
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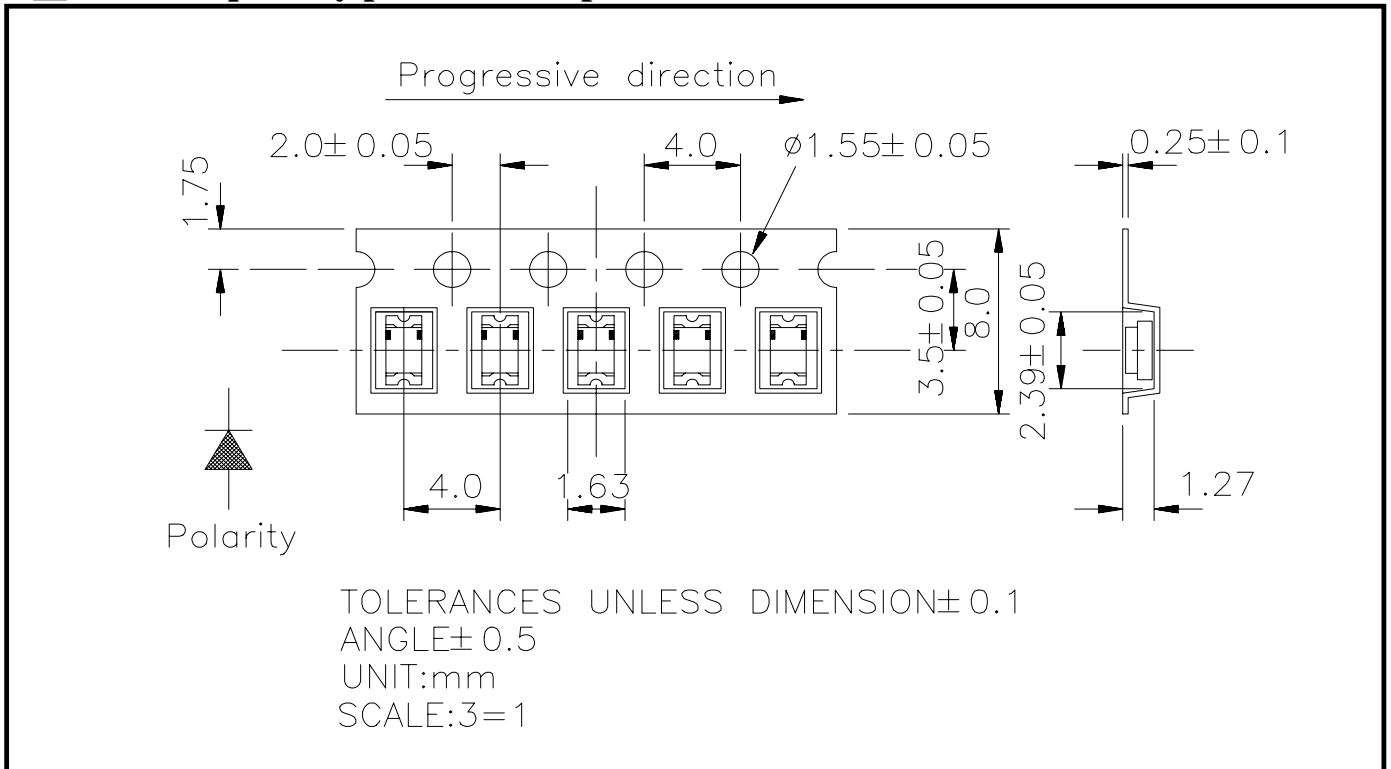
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Package Dimension :



Loaded quantity per reel 3000 pcs/reel :





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■ Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _r	5	V
Forward Current	I _f	30	mA
Operating Temperature	T _{opr}	-20 ~ +80	°C
Storage Temperature	T _{stg}	-30 ~ +100	°C
Soldering Temperature	T _{sol}	260 (for 5 second)	°C
Electrostatic Discharge	ESD	1000	V
Power Dissipation	P _d	120	mW
Peak Forward Current(Duty 1/10 @ 1KHZ)	I _f (Peak)	100	mA

■ Electronic Optical Characteristics :

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous intensity	I _v	-----	4	-----	mcd	I _f =20mA
		36	62	-----	mcd	I _f =20mA
Viewing Angle	2θ 1/2	-----	140	-----	deg	I _f =20mA
Peak Wavelength	λ _p	-----	502	-----	nm	I _f =20mA
Dominant Wavelength	λ _d	-----	505	-----	nm	I _f =20mA
Spectrum Radiation Bandwidth	△λ	-----	30	-----	nm	I _f =20mA
Forward Voltage	V _f	-----	3.5	4.0	V	I _f =20mA
Reverse Current	I _r	-----	-----	10	μA	V _r =5V



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Reliability Test Item And Condition

NO	Item	Test Conditions	Test Hours/Cycle	Sample Size	Ac/Re
1	Solder Heat	TEMP : 260°C ± 5 °C	5 SEC	76 Pcs	0/1
2	Temperature Cycle	H : +85°C 30min ∩ 5 min L : -55°C 30min	50 CYCLE	76 Pcs	0/1
3	Thermal Shock	H : +100°C 5min ∩ 10 sec L : -10°C 5min	50 CYCLE	76 Pcs	0/1
4	High Temperature Storage	TEMP : 100°C	1000 HRS	76 Pcs	0/1
5	Low Temperature Storage	TEMP : -55°C	1000 HRS	76 Pcs	0/1
6	DC Operating Life	If = 20 mA	1000 HRS	76 Pcs	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 HRS	76 Pcs	0/1



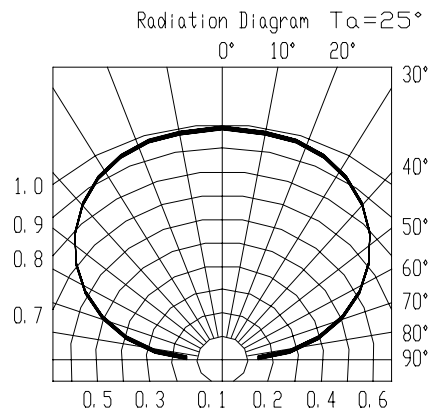
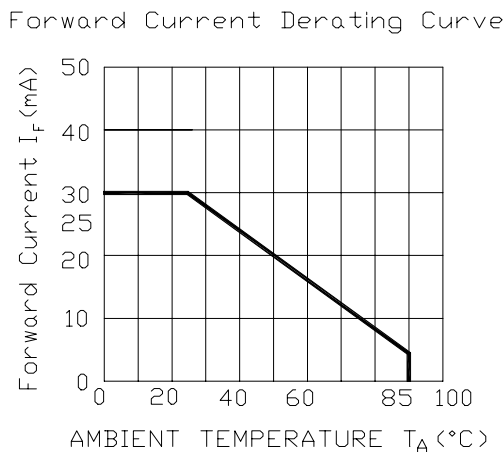
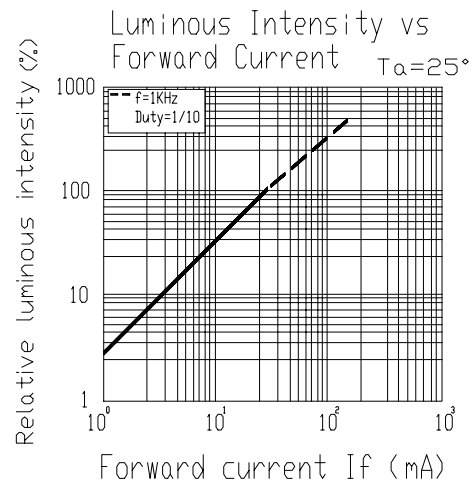
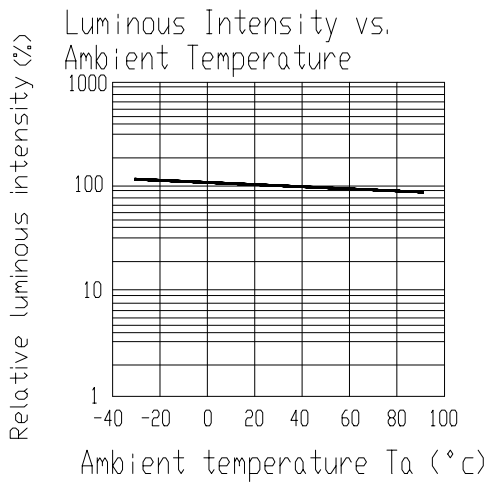
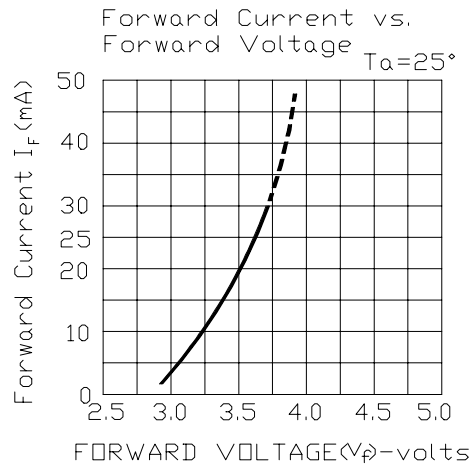
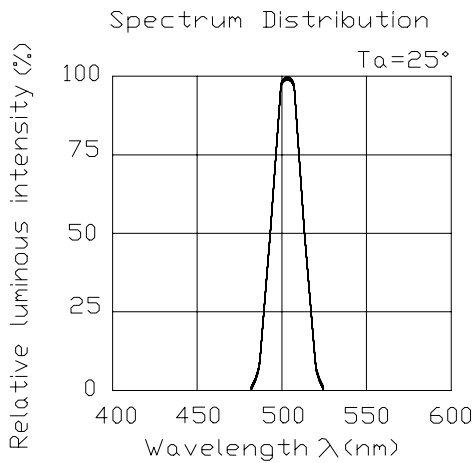
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Typical Electro-Optical Characteristic Curves



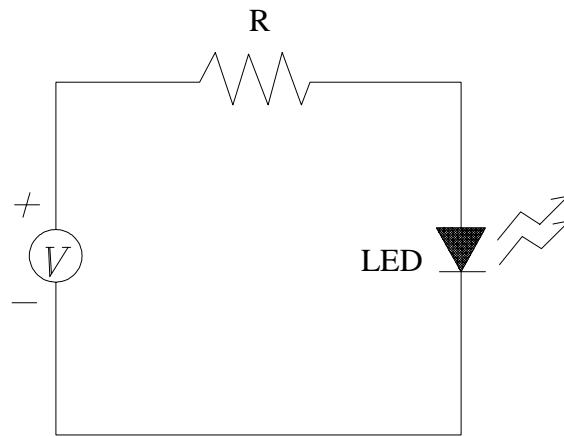


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■ Test Circuit



■ Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

2.1 The operation of temperature and R.H. are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60%.

2.2 Once the package is opened, the products should be used within a week.

Otherwise, they should be keeping in a dampproof box with desiccants.

Considering the tape life , we suggest our customers to use our products within a year(from production date).

2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60% , they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (Normal = blue), you should treat them in the same conditions as 2.3.



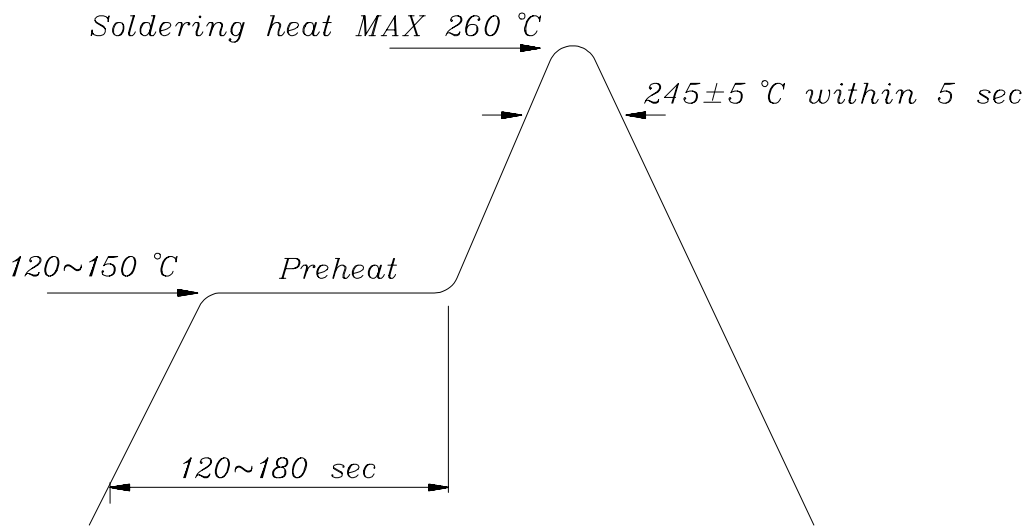
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■ **Soldering heat reliability (DIP)**

Please refer to the following figure :

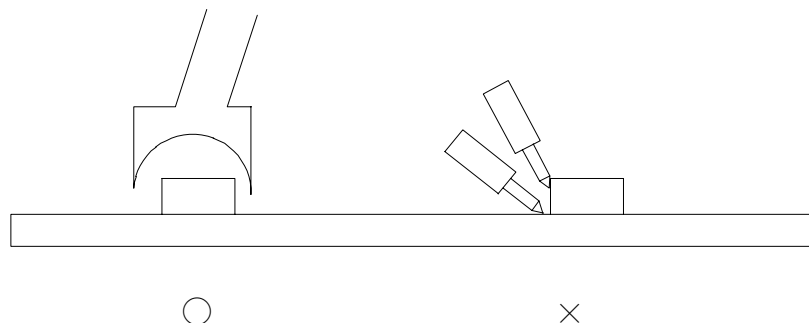


■ **Soldering Iron**

Basic spec is ≤ 5 sec when 260°C. If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of iron should be smaller than 15 W , and temperature should be controllable. Surface temperature of the device should be under 230 °C .

■ **Rework**

1. Customer must finish rework within 5 sec under 260°C .
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.





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■ Reflow Temp / Time :

